

STS4DNFS30L

N-channel 30V - 0.044Ω - 4A SO-8 STripFET™ MOSFET plus SCHOTTKY rectifier

General features

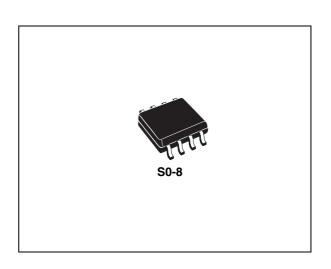
MOSFET	V _{DSS}	R _{DS(on)}	I _D
	30V	<0.056Ω	4A
SCHOTTKY	I _{F(AV)}	V _{RRM}	V _{F(MAX)}

Description

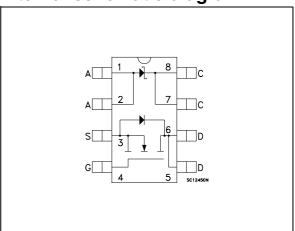
This product associates the latest low voltage STripFET™ in n-channel version to a low drop Schottky diode. Such configuration is extremely versatile in implementing, a large variety of DC-DC converters for printers, portable equipment, and cellular phones.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS4DNFS30L	S4DNFS30L	SO-8	Tape & reel

Contents STS4DNFS30L

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STS4DNFS30L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (v _{gs} = 0)	30	V
V_{DGR}	Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	30	V
V_{GS}	Gate- source voltage	±16	V
I _D	Drain current (continuous) at T _C = 25°C	4	Α
I _D	Drain current (continuous) at T _C = 100°C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT}	Total dissipation at $T_C = 25^{\circ}C$ dual operation	2	W

^{1.} Pulse width limited by safe operating area

Table 2. Schottky absolute maximum ratings

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		30	V
I _{F(RMS)}	RMS forward current		20	Α
I _{F(AV)}	Average forward current	TL=125°C δ=0.5	3	Α
I _{FSM}	Surge non repetitive forward current	tp = 10 ms Sinusoidal	75	Α
I _{RRM}	Repetitive peak reverse current	tp = 2 μs F=1 kHz	1	Α
I _{RSM}	Non repetitive peak reverse current	tp = 100 μs	1	Α
dv/dt	Critical rate of rise of reverse voltage		10000	V/µs

Table 3. Thermal data

R _{thj-a}	Thermal resistance junction-ambient MOSFET ⁽¹⁾	62.5	°C/W
T_J	Junction temperature	-55 to 150	°C
T _{stg}	Storage temperature range	-55 to 150	°C

^{1.} Mounted on FR-4 board (steady state)

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Electrical characteristics STS4DNFS30L

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} =Max rating, T_{C} =125°C			1 10	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±16V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			٧
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2A$ $V_{GS} = 5V, I_D = 2A$		0.044 0.051	0.055 0.065	Ω Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D =2A		5		S
C _{iss}	Input capacitance			330		pF
C _{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, $ $V_{GS} = 0$		90		pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$		40		pF
Qg	Total gate charge			6.5	9	nC
Q_{gs}	Gate-source charge	$V_{DD} = 24V, I_D = 4A,$ $V_{GS} = 5V$		3.6		nC
Q_{gd}	Gate-drain charge	*GS = 0 *		2		nC

^{1.} Pulsed: Pulse duration = $300 \mu s$, duty cycle 1.5.

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =15 V, I_{D} =2A, R_{G} =4.7 Ω , V_{GS} =5V (see Figure 12)		11 100		ns ns
t _{d(off)} t _f	Turn-off delay time Fall time	V_{DD} =15 V, I_{D} =2A, R_{G} =4.7 Ω , V_{GS} =5V (see Figure 12)		25 22		ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				4	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				16	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 4A, V_{GS} = 0$			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 4A$, $V_{DD} = 15V$ $di/dt = 100A/\mu s$, $T_j = 150^{\circ}C$ (see Figure 14)		35 25 1.4		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STS4DNFS30L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

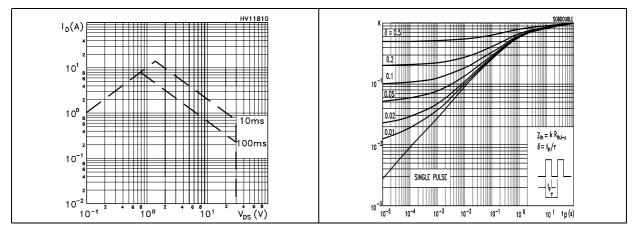


Figure 3. Output characteristics

Figure 4. Transfer characteristics

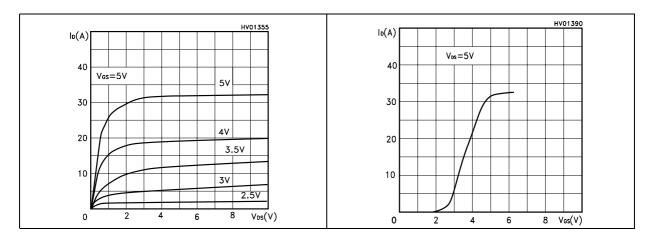


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

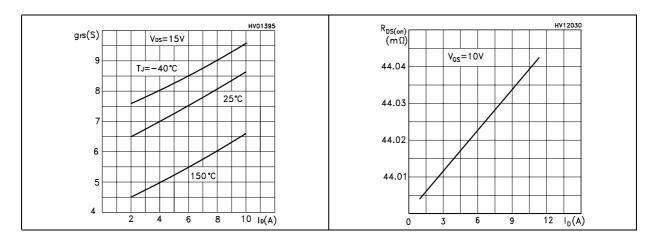


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

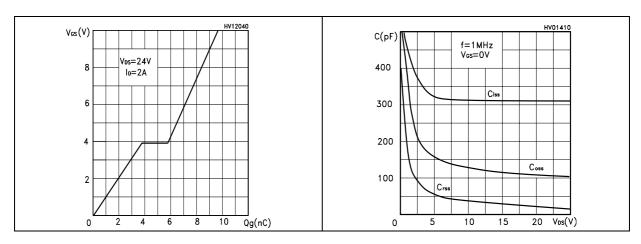


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs. vs. temperature temperature

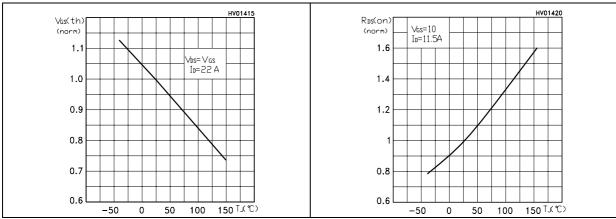
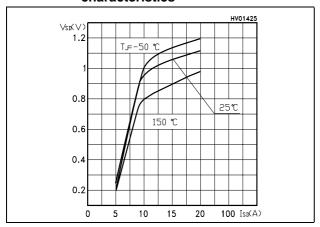


Figure 11. Source-drain diode forward characteristics



Test circuit STS4DNFS30L

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

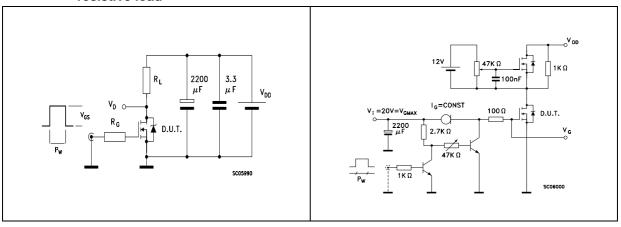


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

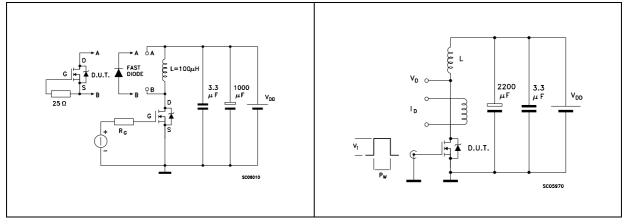
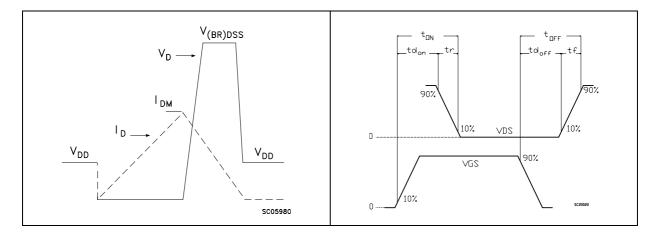


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform

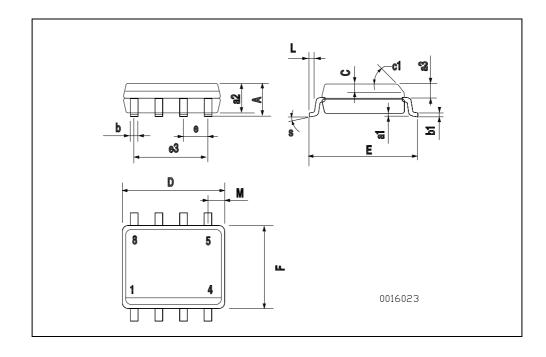


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SO-8 MECHANICAL DAT	SO-8	CHANICAL	DATA
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DIM		mm.			inch		
DIM.	MIN.	TYP	MAX.	MIN.	TYP. MA		
Α			1.75			0.068	
a1	0.1		0.25	0.003		0.009	
a2			1.65			0.064	
аЗ	0.65		0.85	0.025		0.033	
b	0.35		0.48	0.013		0.018	
b1	0.19		0.25	0.007		0.010	
С	0.25		0.5	0.010		0.019	
c1			45	(typ.)		•	
D	4.8		5.0	0.188		0.196	
E	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		3.81			0.150		
F	3.8		4.0	0.14		0.157	
L	0.4		1.27	0.015		0.050	
М			0.6			0.023	
S		•	8 (r	nax.)	•	•	



STS4DNFS30L Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes
21-Jun-2004	2	Complete version
10-Nov-2006	3	The document has been reformatted
26-Jan-2007	4	Typo mistakes on Table 1.

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